

Engineering Development Model

Power Splitter/Combiner 2 Way-0°

ADP-ED7918/2

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : CD636

ELECTRICAL SPECIFICATIONS 75Ω @ +25°C					
Parameter		Min.	Typ.	Max.	Units
Frequency		0.82		772	MHz
Isolation	.82-8.2 MHz		34		dB
	8.2-386 MHz		28		dB
	386-772 MHz		12		dB
Insertion Loss Above 3.0 dB	.82-8.2 MHz		0.12		dB
	8.2-386 MHz		0.18		dB
	386-772 MHz		0.81		dB
Phase Unbalance	.82-8.2 MHz		0.352		deg.
	8.2-386 MHz		0.076		deg.
	386-772 MHz		0.357		deg.
Amplitude Unbalance	.82-8.2 MHz		0.053		dB
	8.2-386 MHz		0.038		dB
	386-772 MHz		0.010		dB
VSWR	SUM Port		1.18		(:1)
	OUT Ports		1.06		(:1)

MAXIMUM RATINGS	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C

PIN CONNECTIONS	
SUM PORT	1
PORT 1	3
PORT 2	4
GROUND	6
Externally connect together & isolate	2 & 5

Functional Diagram



ISO 9001 ISO 14001 AS 9100 CERTIFIED



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MIN-CIRCUITS At: www.minicircuits.com

RF/MICROWAVE COMPONENTS



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Typical Performance Data

FREQ. (MHz)	TOTAL LOSS ¹ (dB)		AMP. UNBAL. (dB)	ISOLATION (dB) 1-2	PHASE UNBAL. (deg.)	FREQ. (MHz)	VSWR (:1)		
	S-1	S-2					S	1	2
0.8	3.10	3.17	0.07	31.60	0.70	0.8	1.07	1.09	1.12
1.0	3.11	3.17	0.06	32.43	0.55	1.0	1.07	1.07	1.10
2.0	3.10	3.16	0.06	34.57	0.37	2.0	1.05	1.05	1.07
3.0	3.09	3.14	0.05	35.62	0.25	3.0	1.05	1.04	1.05
4.0	3.09	3.13	0.04	36.20	0.12	4.0	1.04	1.03	1.04
5.0	3.09	3.13	0.04	36.52	0.12	5.0	1.04	1.02	1.04
11.7	3.09	3.12	0.03	36.45	0.04	11.7	1.04	1.01	1.02
18.3	3.10	3.13	0.04	35.55	0.06	18.3	1.04	1.01	1.02
25.0	3.10	3.15	0.05	34.64	0.03	25.0	1.04	1.01	1.02
31.7	3.11	3.15	0.04	33.83	0.02	31.7	1.04	1.01	1.02
38.3	3.11	3.16	0.04	32.97	0.04	38.3	1.04	1.01	1.02
45.0	3.11	3.16	0.04	32.20	0.03	45.0	1.04	1.02	1.02
51.7	3.12	3.16	0.03	31.51	0.01	51.7	1.04	1.02	1.03
58.3	3.12	3.17	0.04	30.81	0.06	58.3	1.04	1.02	1.03
65.0	3.13	3.17	0.04	30.18	0.02	65.0	1.04	1.02	1.03
84.3	3.14	3.18	0.04	28.52	0.00	84.3	1.04	1.03	1.03
103.6	3.15	3.20	0.05	27.12	0.02	103.6	1.05	1.04	1.04
122.9	3.16	3.20	0.05	25.90	0.08	122.9	1.05	1.04	1.04
142.1	3.18	3.21	0.04	24.79	0.04	142.1	1.06	1.05	1.05
161.4	3.18	3.21	0.04	23.82	0.12	161.4	1.06	1.06	1.05
180.7	3.19	3.23	0.04	22.94	0.13	180.7	1.08	1.06	1.06
200.0	3.21	3.25	0.05	22.09	0.15	200.0	1.09	1.07	1.06
257.1	3.25	3.28	0.03	20.00	0.16	257.1	1.12	1.08	1.07
314.3	3.31	3.33	0.02	18.22	0.21	314.3	1.16	1.10	1.08
371.4	3.38	3.40	0.02	16.66	0.22	371.4	1.21	1.11	1.09
428.6	3.44	3.44	0.01	15.27	0.33	428.6	1.27	1.11	1.09
485.7	3.49	3.50	0.00	13.96	0.30	485.7	1.34	1.12	1.08
542.9	3.61	3.61	0.00	12.73	0.34	542.9	1.43	1.12	1.08
600.0	3.76	3.74	0.02	11.61	0.32	600.0	1.54	1.11	1.08
657.1	3.91	3.89	0.02	10.56	0.37	657.1	1.66	1.12	1.09
714.3	4.13	4.11	0.01	9.60	0.38	714.3	1.83	1.13	1.11
771.4	4.34	4.34	0.01	8.71	0.46	771.4	2.03	1.16	1.16

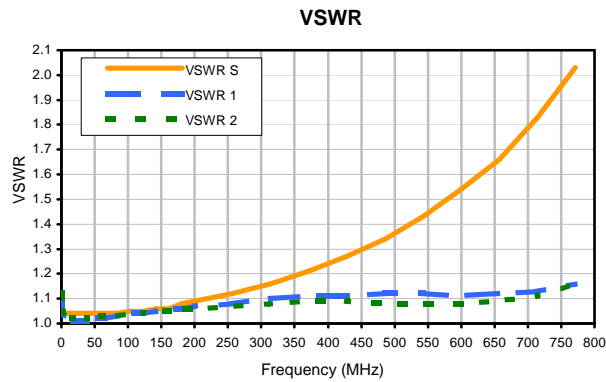
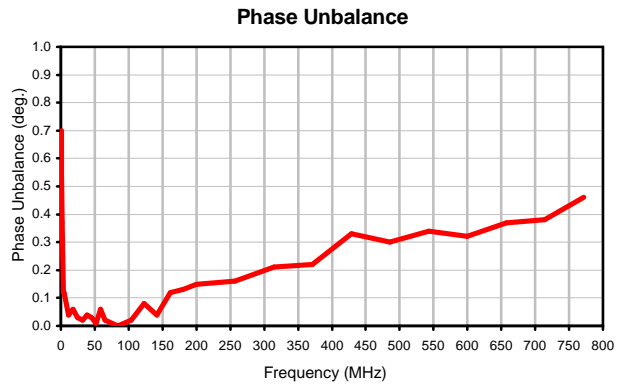
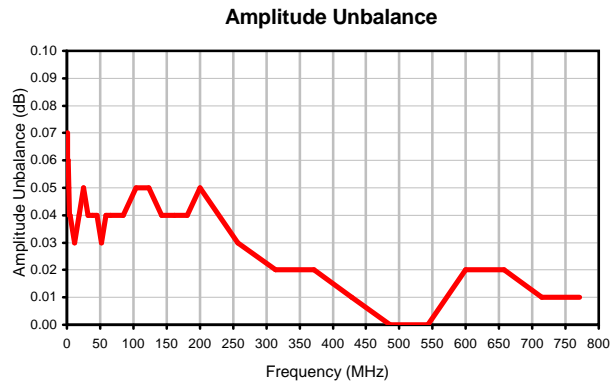
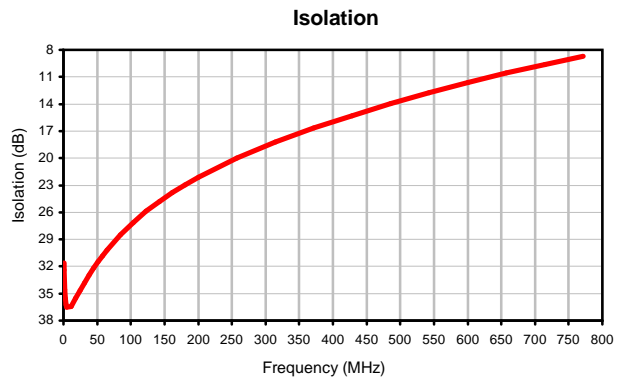
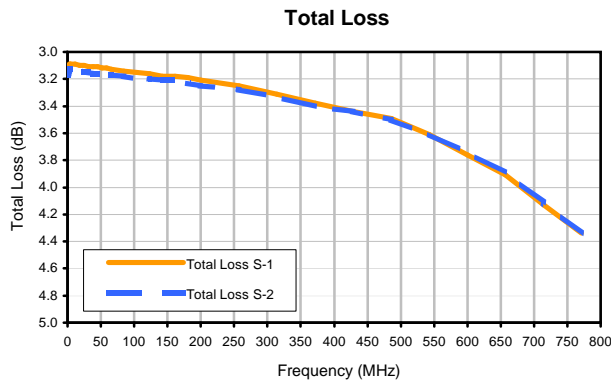
¹Total Loss = Insertion Loss + 3dB Splitter Loss



2 Way-0° Power Splitter/Combiner

ADP-ED7918/2

Typical Performance Curves



Case Style

CD

CD541
CD542
CD636
CD637

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE#	A	B	C	D	E	F	G	H	J	K	L	WT, GRAM
CD541					.082 (2.08)							.15
CD542	.272 (6.91)	.310 (7.87)	.220 (5.58)	.100 (2.54)	.112 (2.84)	.055 (1.40)	.100 (2.54)	.030 (0.76)	.026 (0.66)	.065 (1.65)	.300 (7.62)	.20
CD636					.162 (4.11)							.25
CD637					.206 (5.23)							.40

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
 - For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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Tape & Reel Packaging TR-F34



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
				100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



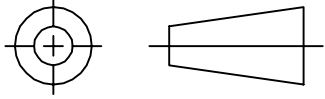
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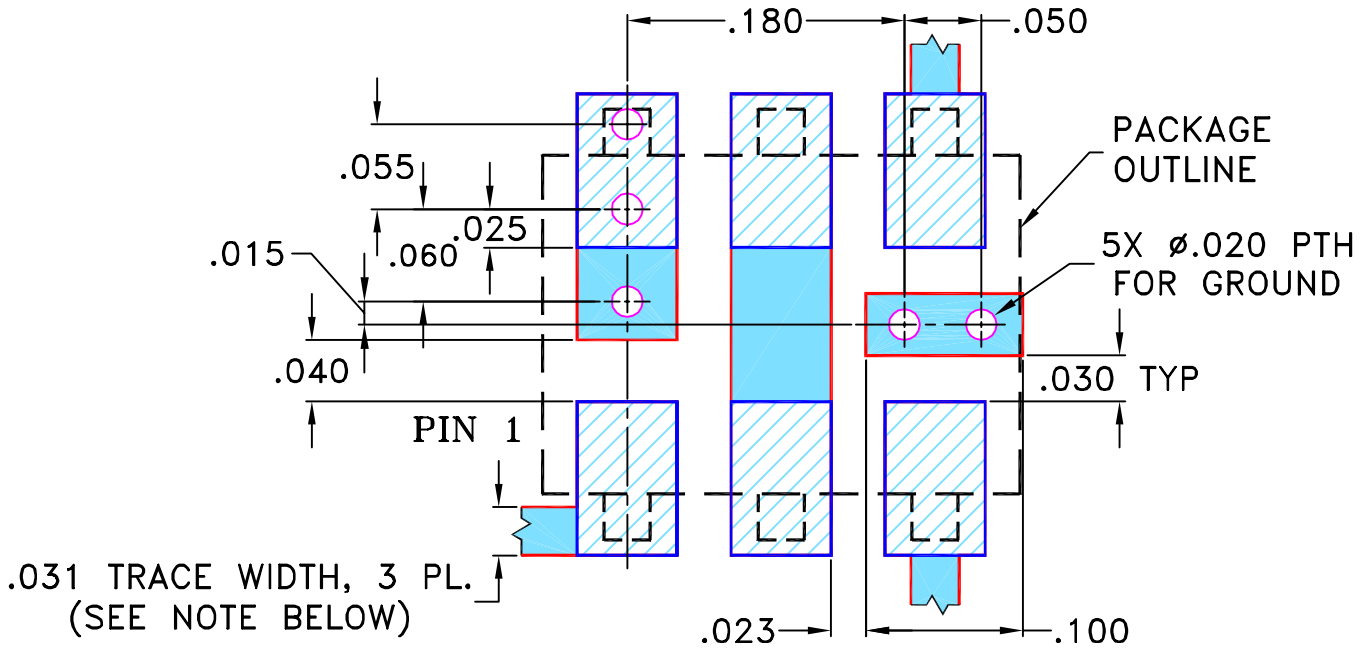
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M81586	NEW RELEASE	12/09/02	MMG	HY
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION
FOR CD542/CD636 CASE STYLES, "mp" PIN CONNECTION



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN MMG	11/21/02
TOLERANCES ON:	CHECKED AV	12/05/02
2 PL DECIMALS ±	APPROVED HY	12/09/02
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

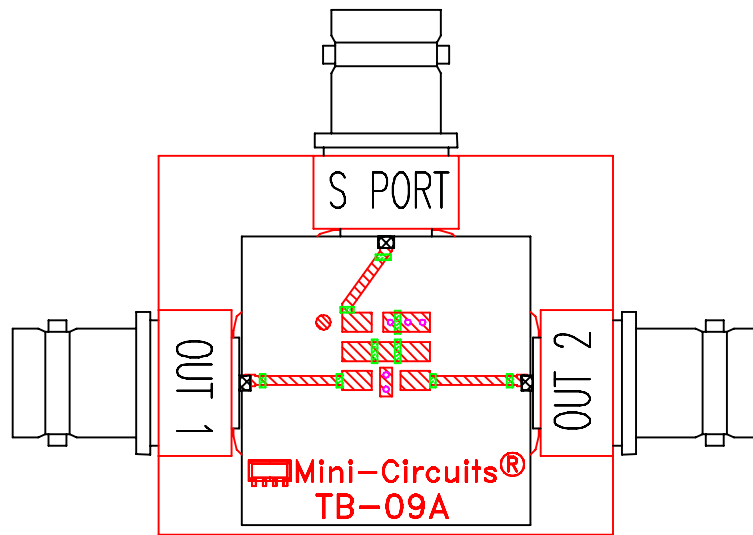
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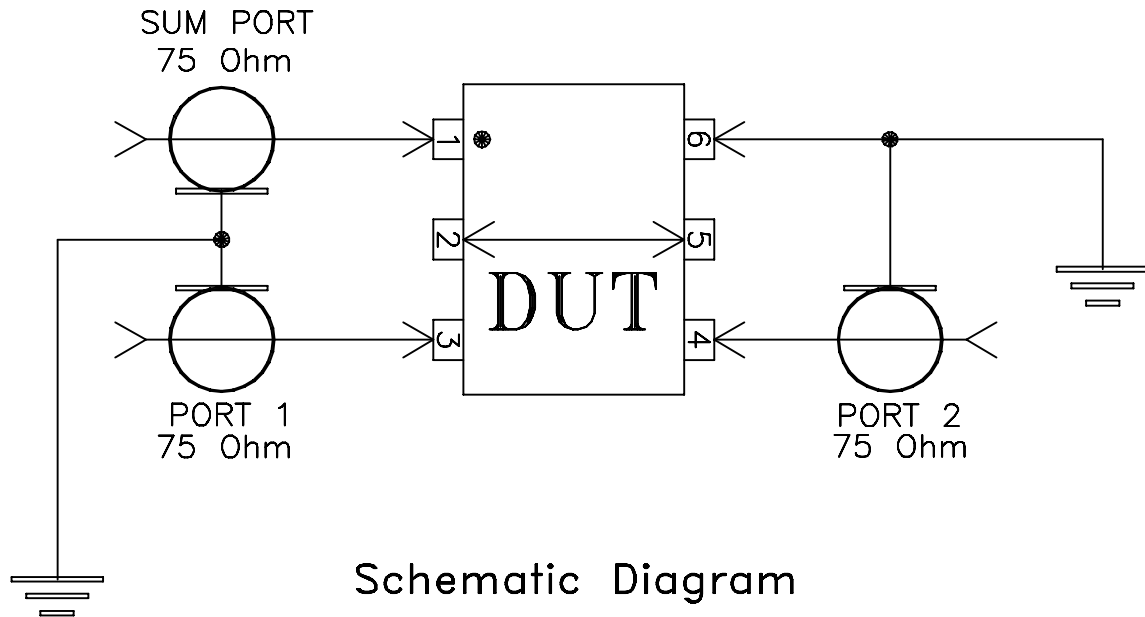
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SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-105	REV: A
FILE: 98PL105	SCALE: 8:1	SHEET: 1 OF 1	

Evaluation Board and Circuit




TB-09



Schematic Diagram

Notes:

1. 75 Ohm BNC Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215